

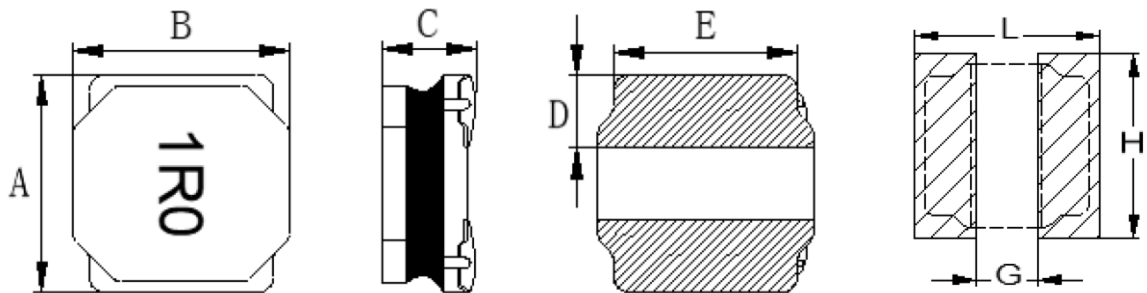
1. Part No. Expression

SPSQ4018BM1R0Y

(a) (b) (c) (d) (e)

- | | |
|--------------------|---------------------|
| (a) Series Code | (d) Inductance Code |
| (b) Dimension Code | (e) Tolerance Code |
| (c) Material Code | |

2. Configuration & Dimensions (Unit: mm)



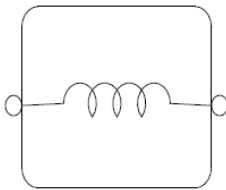
Recommended PCB Layout

- Note:
1. The above PCB layout reference only.
 2. Recommend solder paste thickness at 0.15 mm and above.
 3. A, B Size may slightly bigger than ferrite core dimension after epoxy sealing, but not exceed 0.1mm.
 4. Component height may slightly higher than C size and not exceed 0.1mm, and will be lower after reflow soldering.
 5. Marking: Inductance Code, Black

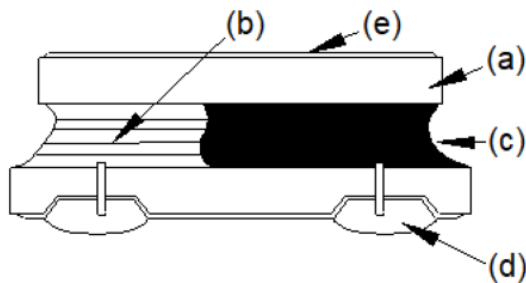
A	B	C	D	E	L	G	H
4.0±0.2	4.0±0.2	1.6±0.2	1.1±0.2	3.5±0.3	4.5 Ref	1.5 Ref	4.5 Ref

NOTE: Specifications subject to change without notice. Please check our website for latest information.

3. Schematic



4. Material List

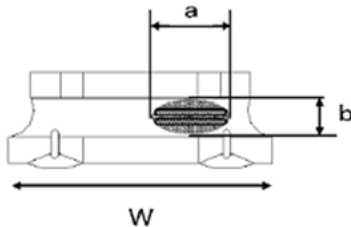


- (a) Core
- (b) Wire
- (c) Glue
- (d) Terminal
- (e) Ink

Void appearance tolerance limit & size of voids occurring to coating resin is specified below.

Exposed wire tolerance limit of coating resin part on product side.

Size of exposed wire occurring to coating resin is specified below:

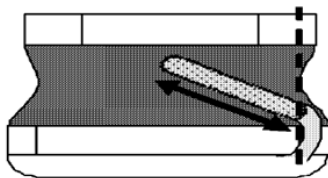


1. Width direction (dimension a) : Acceptable when $a \leq w/2$;

Nonconforming when $a > w/2$

2. Length direction (dimension b): Dimension b is not specified

3. The total area of exposed wire occurring to each side is not greater than 50% of coating resin area and is acceptable



External appearance criterion for exposed wire.

Exposed end of the winding wire at the secondary side should be 2mm and below.

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5. General Specifications

- (a) Reliability test for this part meets AEC-Q200 standard.
- (b) Operating Temp.: -55°C to +125°C (including self-temperature rise)
- (c) Storage Temp.: -55°C to +125°C (on board)
- (d) All test data referenced to 25°C ambient.
- (e) Heat Rated Current (Irms) will cause the coil temperature rise approximately ΔT of 40°C.
- (f) Saturation Current (Isat) will cause inductance L0 to drop approximately 30%.
- (g) Rated Current: The lower value of Isat and Irms.
- (h) Storage Condition (Component in its packaging)
 - i) Temperature: Less than 40°C
 - ii) Humidity: Less than 60% RH

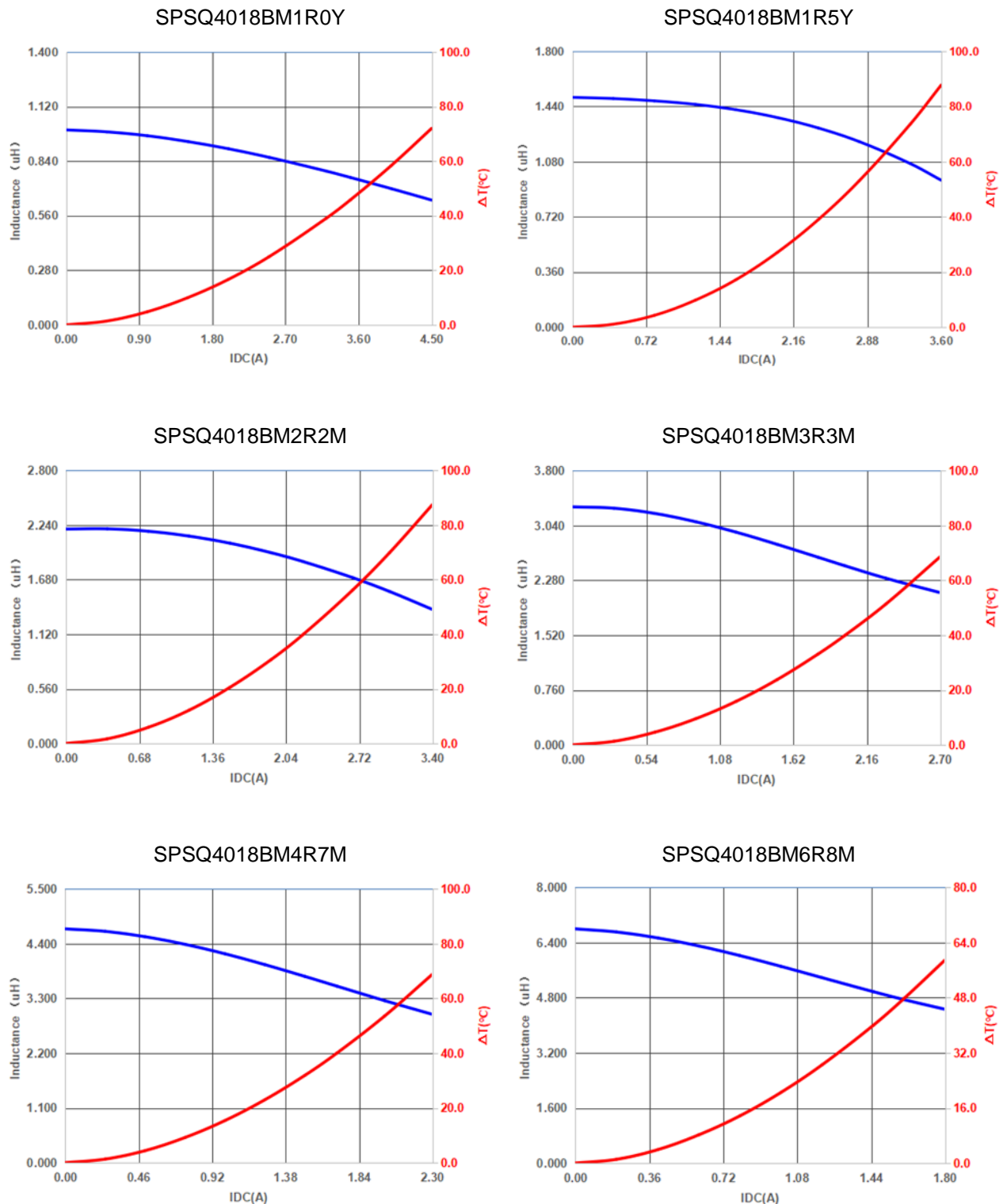
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6. Electrical Characteristics

Part Number	Inductance (μ H) @0A	Test Frequency	I _{rms} (A) Typ	I _{sat} (A) Typ	DCR (Ω) $\pm 20\%$
SPSQ4018BM1R0Y	1.00 $\pm 30\%$	1V/100KHz	3.20	4.00	0.027
SPSQ4018BM1R5Y	1.50 $\pm 30\%$	1V/100KHz	2.40	3.30	0.037
SPSQ4018BM2R2M	2.20 $\pm 20\%$	1V/100KHz	2.20	3.00	0.042
SPSQ4018BM3R3M	3.30 $\pm 20\%$	1V/100KHz	2.00	2.30	0.055
SPSQ4018BM4R7M	4.70 $\pm 20\%$	1V/100KHz	1.70	2.00	0.070
SPSQ4018BM6R8M	6.80 $\pm 20\%$	1V/100KHz	1.45	1.60	0.098
SPSQ4018BM100M	10.0 $\pm 20\%$	1V/100KHz	1.20	1.30	0.150
SPSQ4018BM150M	15.0 $\pm 20\%$	1V/100KHz	0.85	1.10	0.210
SPSQ4018BM220M	22.0 $\pm 20\%$	1V/100KHz	0.72	0.90	0.290
SPSQ4018BM330M	33.0 $\pm 20\%$	1V/100KHz	0.55	0.70	0.460
SPSQ4018BM470M	47.0 $\pm 20\%$	1V/100KHz	0.44	0.60	0.650
SPSQ4018BM680M	68.0 $\pm 20\%$	1V/100KHz	0.32	0.52	1.000
SPSQ4018BM101M	100 $\pm 20\%$	1V/100KHz	0.28	0.42	1.450
SPSQ4018BM151M	150 $\pm 20\%$	1V/100KHz	0.22	0.34	2.300
SPSQ4018BM221M	220 $\pm 20\%$	1V/100KHz	0.17	0.275	3.800

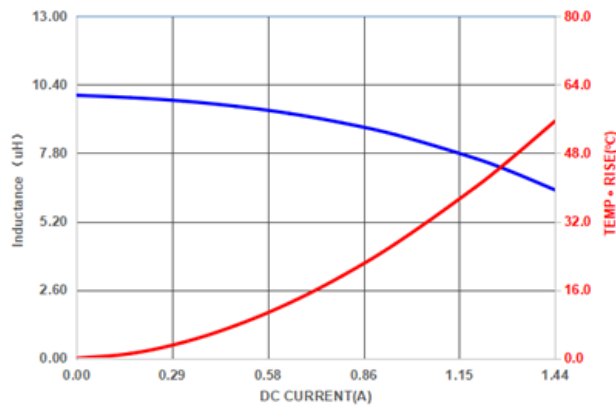
NOTE: Specifications subject to change without notice. Please check our website for latest information.

7. Characteristics Curve

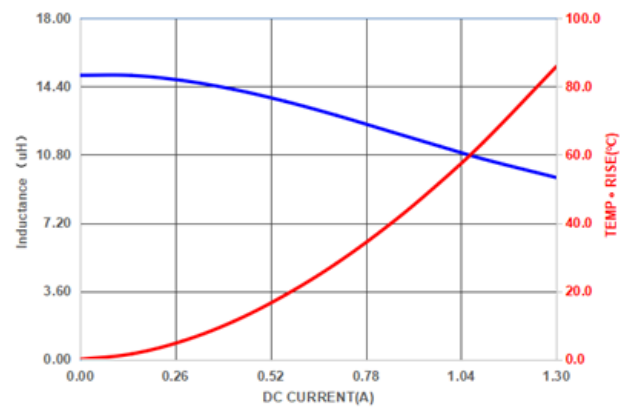


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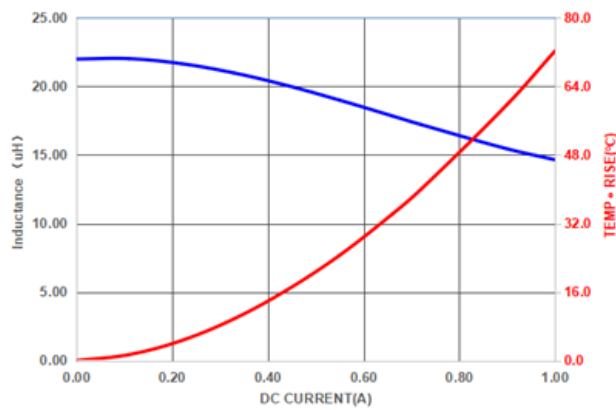
SPSQ4018BM100M



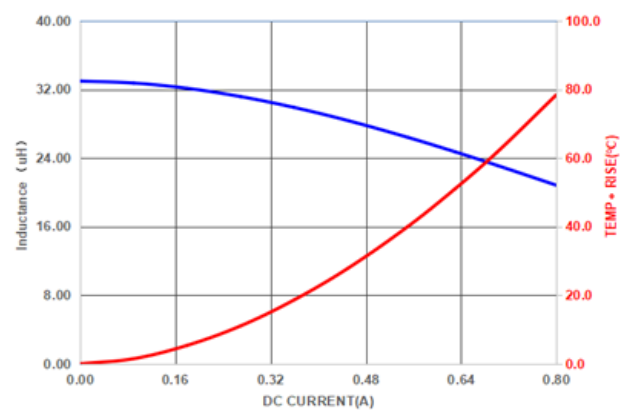
SPSQ4018BM150M



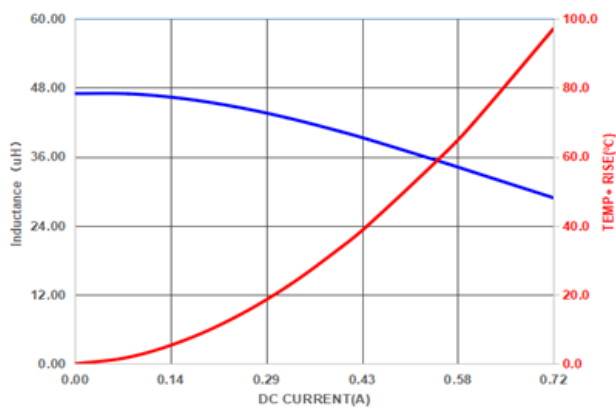
SPSQ4018BM220M



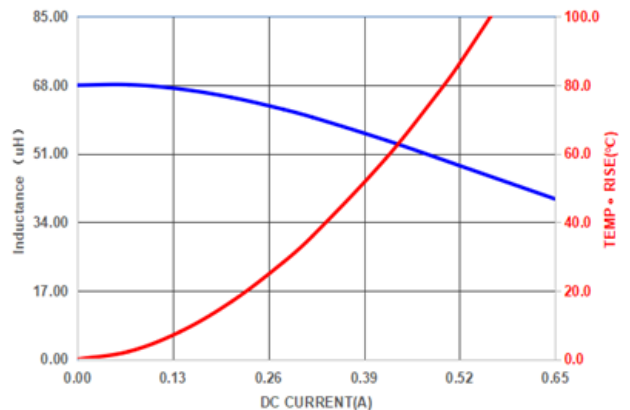
SPSQ4018BM330M



SPSQ4018BM470M

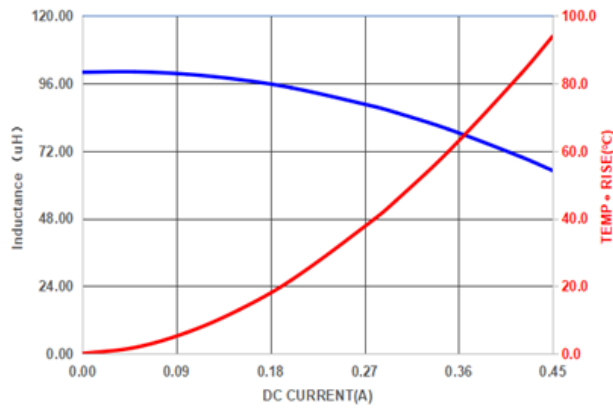


SPSQ4018BM680M

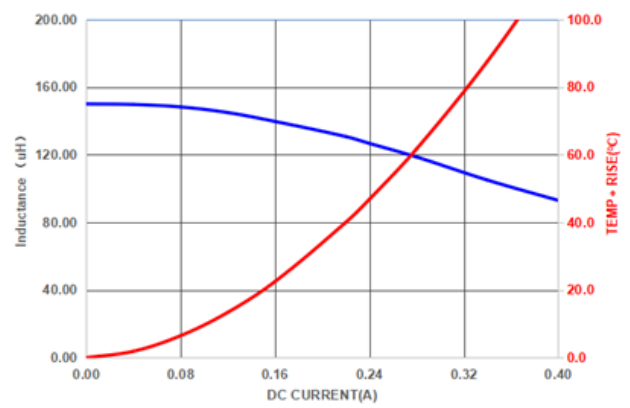


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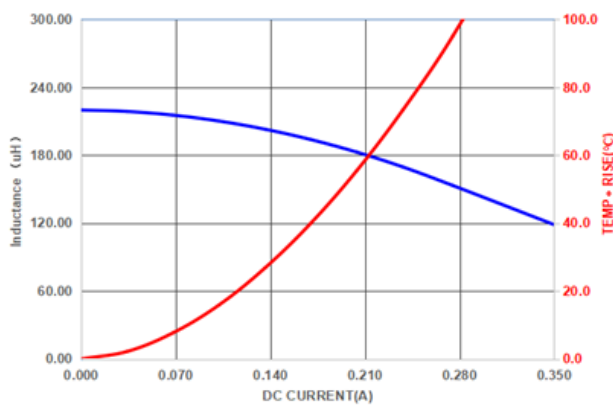
SPSQ4018BM101M



SPSQ4018BM151M



SPSQ4018BM221M



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8. Soldering Specification

Mildly activated rosin fluxes are preferred. Our terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-1. IR Soldering Reflow

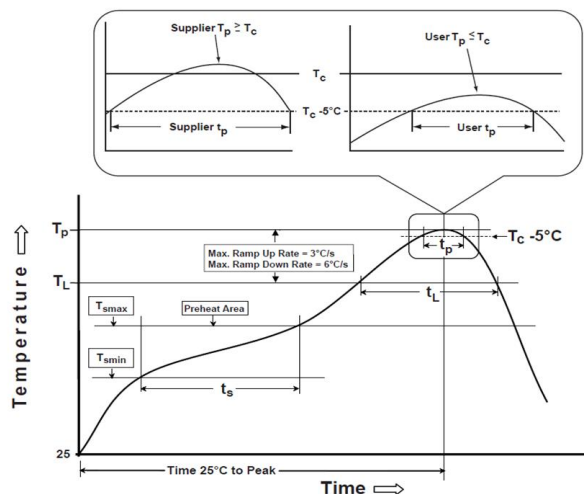
Recommended temperature profiles for lead free re-flow soldering in Figure 1, Table 1.1 & 1.2 (J-STD-020E).

8-2. Iron Reflow

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended (Figure 2).

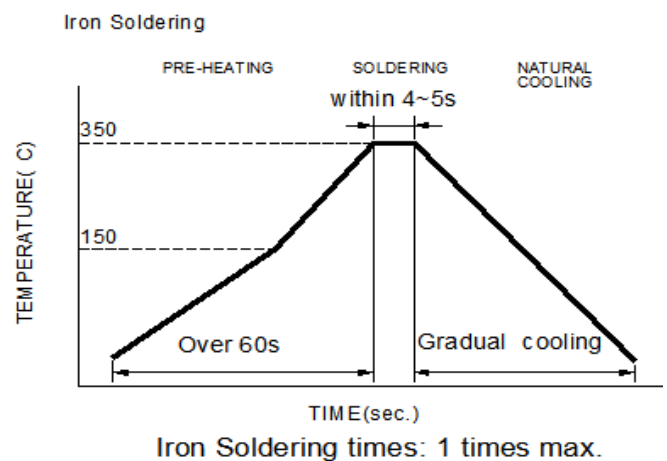
Note:

- Preheat circuit and products to 150°C.
- 355°C tip temperature (Max.)
- Never contact the ceramic with the iron tip
- 1.0mm tip diameter (Max.)
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 4~5 sec.



Reflow times: 3 times Max

Figure 1: IR Soldering Reflow



Soldering iron method: 350±5°C Max

Figure 2: Iron soldering temperature profiles

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Table (1.1) Reflow Profiles

Profile Type:	Pb-Free Assembly
Preheat	
-Temperature Min (T_{\min})	150°C
-Temperature Max (T_{\max})	200°C
-Time (t_s) from (T_{\min} to T_{\max})	60-120seconds
Ramp-up rate (T_L to T_p)	3°C /second max.
Liquids temperature (T_L)	217°C
Time (t_L) maintained above T_L	60-150 seconds
Classification temperature (T_c)	See Table (1.2)
Time (t_p) at $T_c - 5^\circ\text{C}$ (T_p should be equal to or less than T_c .)	* < 30 seconds
Ramp-down rate (T_p to T_L)	6°C /second max.
Time 25°C to peak temperature	8 minutes max.

T_p : maximum peak package body temperature, **T_c** : the classification temperature.

For user (customer) **T_p** should be equal to or less than **T_c** .

*Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

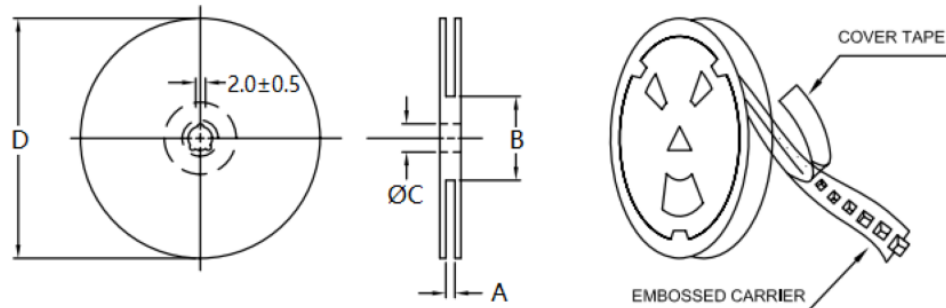
	Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
PB-Free Assembly	<1.6mm	260°C	260°C	260°C
	1.6-2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

Reflow is referred to standard IPC/JEDEC J-STD-020E.

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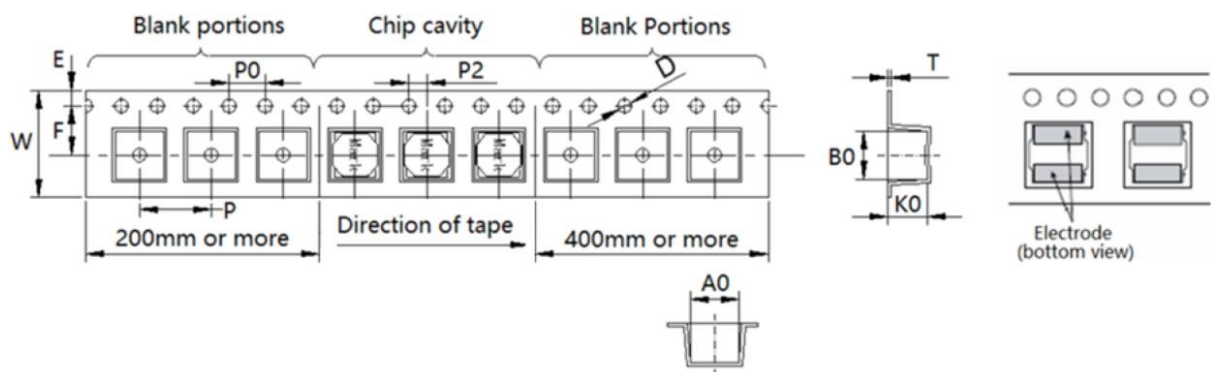
9. Packaging Information

9-1. Reel Dimension (Unit: mm)



Type	A	B	C	D
13"x12mm	12.4+2.0/-0.0	100.0±2.0	13.0+0.5/-0.2	330.0±3.0

9-2. Tape Dimension (Unit: mm)



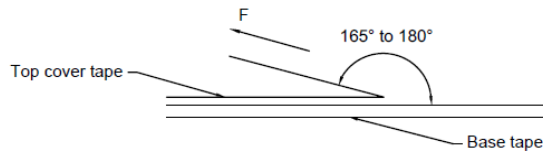
B0	A0	K0	P	W	T
4.40±0.10	4.40±0.10	2.00±0.10	8.00±0.10	12.00±0.30	0.35±0.10
E	F	D	P0	P2	-
1.75±0.10	5.50±0.10	1.50±0.10	4.00±0.10	2.00±0.10	-

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9-3. Packaging Quantity (Unit: Pcs)

Chip/ Reel	3,500
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9-4. Tearing Off Force



The force for tearing off cover tape is according to the follow table, in the arrow direction under the following conditions.

(Referenced ANSI/EIA-481-D-2008 of 4.11 standard)

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed (mm/min)	Tape Size	8 mm	12 to 56 mm	72 mm or Wider
5~35	45~85	860~1060	300±10	Tearing Off Force (grams)	10~100	10~130	10~150

Application Notice

1. Storage Conditions

To maintain the solderability of terminal electrodes:

- (a) Recommended products should be used within 12 months from the time of delivery.
- (b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation

- (a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- (b) Vacuum pick up is strongly recommended for individual components.
- (c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

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